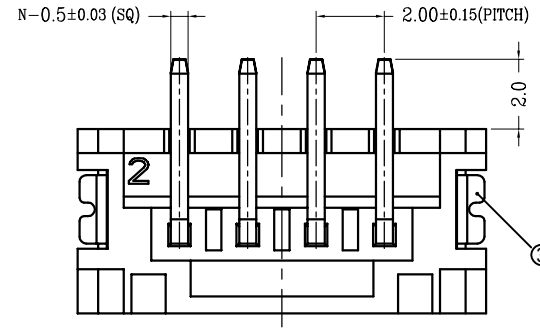
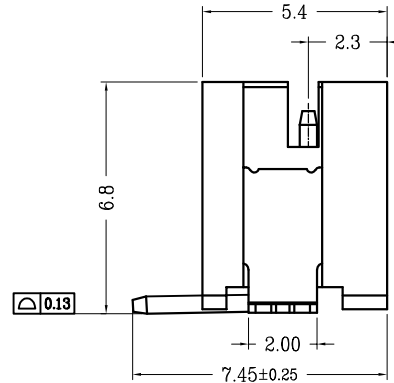
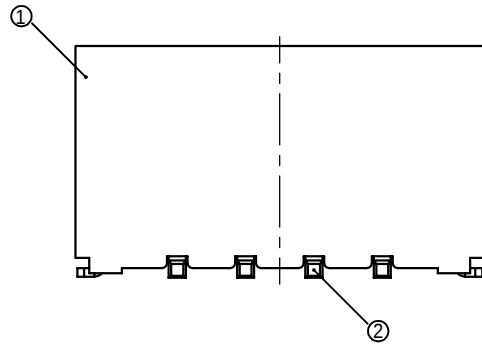
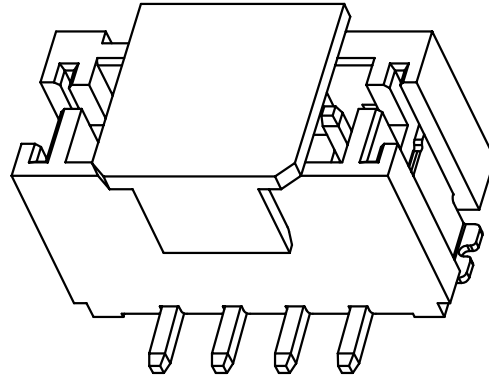
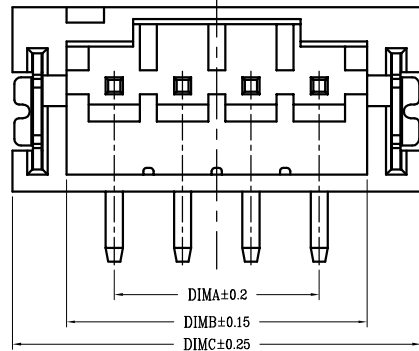


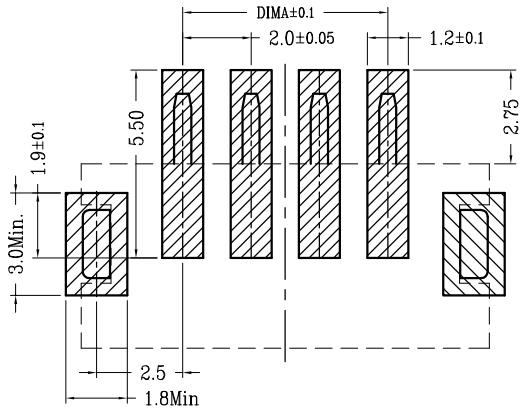
技术指标(Technical Index):

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
(The surface of the plastic parts should be smooth, no rough edges, no obvious shrinkage, defects, cracks and other phenomena)
2. 不同pin位吸盖加入/取出力有差异, 实属正常现象。
(It is normal than there are difference between suction cap and suction cap at different Pin postitions)
3. 温度范围(Temperature range): $-40^{\circ}\text{C}\sim 85^{\circ}\text{C}$.
4. 额定电压(Rated voltage): 200V, AC.
5. 接触电阻(Contact resistance):
 $\leq 55\text{m}\Omega$ (initial) per contact, $\leq 25\text{m}\Omega$ Change allowed.
6. 绝缘电阻(Insulation resistance): $\geq 1000\text{M}\Omega$.



CKT	DIM A	DIM B	DIM C
2	2.00	4.80	7.95
3	4.00	6.80	9.95
4	6.00	8.80	11.95
5	8.00	10.80	13.95
6	10.00	12.80	15.95
7	12.00	14.80	17.95
8	14.00	16.80	19.95
9	16.00	18.80	21.95
10	18.00	20.80	23.95
11	20.00	22.80	25.95
12	22.00	24.80	27.95
13	24.00	26.80	29.95
14	26.00	28.80	31.95
15	28.00	30.80	33.95
16	30.00	32.80	35.95
17	32.00	34.80	37.95
18	34.00	36.80	39.95
19	36.00	38.80	41.95
20	38.00	40.80	43.95

适用线路板



序号 (NO.)	品名 (Name)	材质 (Material)
①	2.00 F型立式WTB胶芯 2.00Pitch S/T Wire To Board Housing(H=6.8)	LCP UL94V-0 本色 Natural
②	2.00 F型立式WTB端子 2.00 Pitch S/T Wire To Board Terminal(H=6.8)	铜合金/表面镀锡 Copper Alloy/ Tin Plating
③	2.00 F型立式WTB焊片 2.00 Pitch S/T Wire To Board Fitting Nail(H=6.8)	铜合金/表面镀锡 Copper Alloy/ Tin Plating
④	2.00 F型立式WTB吸盖 2.00 Pitch S/T Wire To Board Cover(H=6.8)	LCP UL94V-0 本色 Natural



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<http://www.wanjunda.com>

图号 (DWG NO)		单位(UNIT): MM
版本 (REV)		比例(SCALE) 1:1
日期 (DATE)		未注公差 TOLERANCE UNSPECIFIED
设计 (DESIGN)		X.X ±0.30
审核 (CHECKED)		X.XX ±0.20
核准 (APPROVED)		X.XXX ±0.10
		X" ±5°
		X.X" ±2°